

General Description

The IRLH5030TRPBF use advanced SGT MOSFET technology to provide low RDS(ON), low gate charge, fast switching and excellent avalanche characteristics.

This device is specially designed to get better ruggedness.

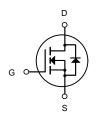
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DFN5X6-8L

General Features

 $V_{DS} = 100V I_{D} = 75A$

 $R_{DS(ON)} < 7.5 m\Omega V_{GS} = 10 V$



N-Channel MOSFET

Applications

Consumer electronic power supply Motor control

Synchronous-rectification Isolated DC

Synchronous-rectification applications

Package Marking and Ordering Information

| Product ID | Pack | Brand | Qty(PCS) |
|---------------|-----------|------------|----------|
| IRLH5030TRPBF | DFN5X6-8L | HXY MOSFET | 5000 |

Absolute Maximum Ratings at $T_j=25^{\circ}C$ unless otherwise noted

| Parameter | Symbol | Value | Unit |
|--|----------------|------------|------|
| Drain source voltage | VDS | 100 | V |
| Gate source voltage | VGS | ±20 | V |
| Continuous drain current ¹⁾ | ID | 75 | А |
| Pulsed drain current ²⁾ | ID, pulse | 300 | Α |
| Power dissipation ³⁾ | P _D | 97 | W |
| Single pulsed avalanche energy ⁵⁾ | EAS | 90 | mJ |
| Operation and storage temperature | Tstg,Tj | -55 to 150 | °C |
| Thermal resistance, junction-case | RθJC | 1.3 | °C/W |



Electrical Characteristics (T_J=25°C unless otherwise specified)

| Symbol | Parameter Test Condition | | Min. | Тур. | Max. | Units |
|----------------------|--|--|------|------|------|--------------|
| Off Charac | cteristic | | | | | |
| V _{(BR)DSS} | Drain-Source Breakdown Voltage | V _{GS} =0V, I _D =250μA | 100 | - | - | V |
| I _{DSS} | Zero Gate Voltage Drain Current | V _{DS} =100V, V _{GS} =0V, | - | - | 1.0 | μA |
| I _{GSS} | Gate to Body Leakage Current | V _{DS} =0V, V _{GS} = ±20V | - | - | ±100 | nA |
| On Charac | cteristics | | | • | | |
| $V_{GS(th)}$ | Gate Threshold Voltage | V _{DS} =V _{GS} , I _D =250μA | 1.0 | 1.6 | 2.5 | V |
| В | Static Drain-Source on-Resistance | V _{GS} =10V, I _D =20A | - | 6.4 | 7.5 | mΩ |
| $R_{DS(on)}$ | note3 | V _{GS} =4.5V, I _D =8A | - | 9.2 | 11.4 | mΩ |
| Dynamic (| Characteristics | | | • | | |
| C _{iss} | Input Capacitance | | - | 2944 | - | pF |
| Coss | Output Capacitance | V _{DS} =50V, V _{GS} =0V, | - | 736 | - | pF |
| C _{rss} | Reverse Transfer Capacitance | f=1.0MHz | - | 2.04 | - | pF |
| Qg | Total Gate Charge | \/ -E0\/ -20A | _ | 39.4 | - | nc |
| Q _{gs} | Gate-Source Charge | V_{DS} =50V, I_{D} =30A, V_{GS} =10V | - | 5.6 | - | nc |
| Q_{gd} | Gate-Drain("Miller") Charge | VGS-10V | - | 7.6 | - | nc |
| Switching | Characteristics | | | | | |
| t _{d(on)} | Turn-on Delay Time | | _ | 13 | - | nc |
| t _r | Turn-on Rise Time | V _{DD} =50V, I _D =25A, | _ | 27.5 | - | nc |
| t _{d(off)} | Turn-off Delay Time | $R_G=6\Omega$, $V_{GS}=10V$ | _ | 45.5 | - | nc |
| t _f | Turn-off Fall Time | | _ | 41.5 | - | nc |
| Drain-Sou | rce Diode Characteristics and Maxim | um Ratings | | | | |
| Is | Maximum Continuous Drain to Source Diode Forward | | _ | _ | 75 | Α |
| | Current | | | | | |
| I _{SM} | Maximum Pulsed Drain to Source Diode Forward Current | | | - | 300 | Α |
| V_{SD} | Drain to Source Diode Forward Voltage | V _{GS} =0V, I _S =30A | - | - | 1 | V |
| t _{rr} | Body Diode Reverse Recovery Time | T =25°C | - | 177 | - | ns |
| Qrr | Body Diode Reverse Recovery Charge | T _J =25°C, I _F =12A,dI/dt=100A/μs | - | 1291 | - | nc |

Notes:1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature

- 2. EAS condition: T_J =25°C, V_{DD} =50V, V_G =10V, R_G =25 Ω , L=0.5mH, I_{AS} =19A
- 3. Pulse Test: Pulse Width≤300µs, Duty Cycle≤0.5%

N-SGT Enhancement Mode MOSFET

Typical Performance Characteristics

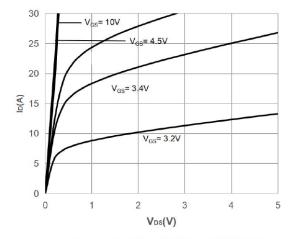


Figure 1: Output Characteristics

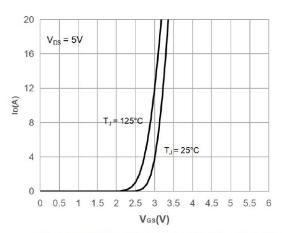


Figure 2: Typical Transfer Characteristics

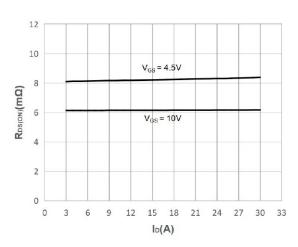


Figure 3: On-resistance vs. Drain Current

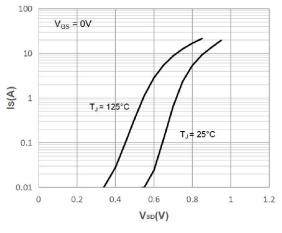


Figure 4: Body Diode Characteristics

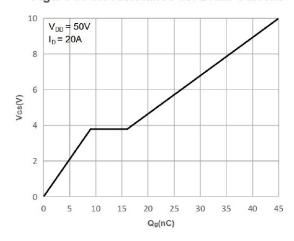


Figure 5: Gate Charge Characteristics

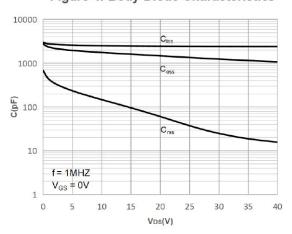


Figure 6: Capacitance Characteristics

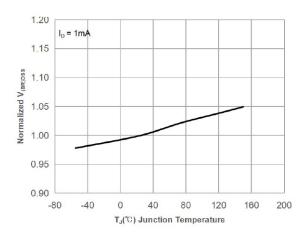


Figure 7: Normalized Breakdown voltage vs.
Junction Temperature

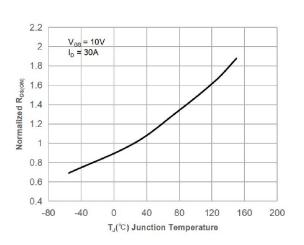


Figure 8: Normalized on Resistance vs.
Junction Temperature

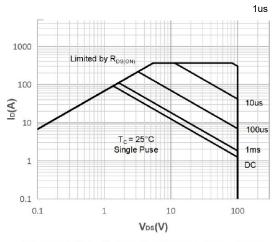


Figure 9: Maximum Safe Operating Area

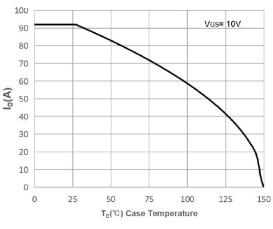


Figure 10: Maximum Continuous Drian Current vs. Case Temperature

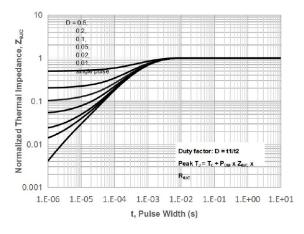


Figure 11: Normalized Maximum Transient
Thermal Impedance

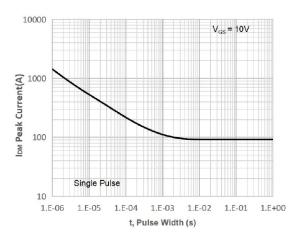
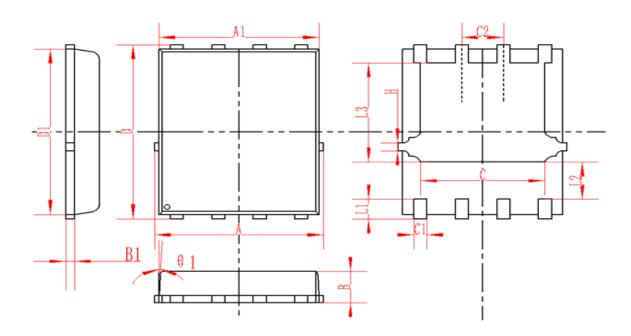


Figure 12: Peak Current Capacity

DFN5X6-8L Package Information



| SYMBOL | MM | | INCH | | | |
|--------|----------|---------|----------|-------|--------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| А | 4.95 | 5 | 5.05 | 0.195 | 0.197 | 0.199 |
| A1 | 4.82 | 4.9 | 4.98 | 0.190 | 0.193 | 0.196 |
| D | 5.98 | 6 | 6.02 | 0.235 | 0.236 | 0.237 |
| D1 | 5.67 | 5.75 | 5.83 | 0.223 | 0.226 | 0.230 |
| В | 0.9 | 0.95 | 1 | 0.035 | 0.037 | 0.039 |
| B1 | 0.254REF | | 0.010REF | | | |
| С | 3.95 | 4 | 4.05 | 0.156 | 0.157 | 0.159 |
| C1 | 0.35 | 0.4 | 0.45 | 0.014 | 0.016 | 0.018 |
| C2 | | 1.27TYP | | | 0.5TYP | |
| θ1 | 8° | 10° | 12° | 8° | 10° | 12° |
| L1 | 0.63 | 0.64 | 0.65 | 0.025 | 0.025 | 0.026 |
| L2 | 1.2 | 1.3 | 1.4 | 0.047 | 0.051 | 0.055 |
| L3 | 3.415 | 3.42 | 3.425 | 0.134 | 0.135 | 0.135 |
| Η | 0.24 | 0.25 | 0.26 | 0.009 | 0.010 | 0.010 |



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